

IAP20 Rec'd PCT/PTO 23 MAY 2006

APPLICATION DATA SHEET**Applicant Information**

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Postal Address Line One:: c/o Mitsui Mining & Smelting Co., Ltd.  
Postal Address Line Two:: Copper Foil Sector Copper Foil Division  
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**Correspondence Information**

Correspondence Customer Number:: 06449

**Application Information**

Title Line One::MULTILAYERED PRINTED WIRING BOARD AND  
Title Line Two:: MANUFACTURING METHOD THEREOF  
Total Drawing Sheets:: 22  
Formal Drawings?:: New  
Application Type:: Utility  
Docket Number:: 3209-115

Secrecy Order in Parent Appl?:: No

**Representative Information**

Representative Customer Number:: The practitioners associated  
Representative Customer Number:: with customer number 06449

**Domestic Priority Information**

This application is a:: 371 of  
>Application One::PCT/JP2004/018355  
Filing Date:: December 9, 2004  
Patent Number::

**Foreign Priority Information**

Foreign Application One:: JP2003-418376  
Filing Date:: December 16, 2003  
Country:: Japan  
Priority Claimed:: Yes

**Assignment Information**

Assignee name:: Mitsui Mining & Smelting Co., Ltd.  
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